

Intel® Firmware Support Package for Intel Atom® C3XXX Product Family

Release Notes

Production Validated 002

June 2018



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Revision History

Date	Revision	Description
June 2018	003	Production Validated 002
October 2017	002	Production Validated 001
March 2017	001	Initial release - Production Candidate 001



1.0 Introduction

This package contains required binary image(s) and collateral for the Intel® Firmware Support Package (Intel® FSP) for the Intel Atom® C3XXX Product Family (formerly Denverton-NS).

This Intel® Firmware Support Package (Intel® FSP) is compliant with the Intel® FSP External Architecture Specification v2.0 (FSP EAS v2.0).

This document provides system requirements, installation instructions, issues and limitations, and legal information.

To learn more about this product, refer to:

- New features listed in <u>Section 2.0</u> or in the help.
- Reference documentation listed in <u>Section 1.4</u>.
- Installation instructions listed in <u>Section 4.1</u>.

1.1 Component Information

The software in this release has been developed and validated using the following information as shown in <u>Table 1</u>.

Table 1. Intel® FSP Component Information

Component	Version
Code Base	EDKII
Core Version	SVN r90465
Memory Reference Code Version	95042B
Reference Code Build Version	15D62

Note: Validation was done on Harcuvar B1 with Intel® Atom® C3XXX SoC B1 (QMEH) stepping only.



1.2 Bootloader Requirements

It is expected that the bootloader perform the following:

• Configure the HSUART device for the serial port. Refer to the UPD Data Region section of the Intel Atom® C3XXX Product Family Intel® Firmware Support Package (Intel® FSP) Integration Guide.

Note: Intel Atom® C3XXX Product Family Intel® FSP does **NOT** support legacy serial port.

- Implement the following functions depending on specific platform requirements:
 - Addition of support for Intel Atom® C3XXX Product Family (A0/A1/B0/B1/Cx stepping) silicon
 - Addition of support for required boards/platforms
 - Setup of the operating environment for the Intel® FSP Application
 Programming Interfaces (APIs) that includes, but is not limited to, the following:
 - o CPU initialization
 - Loading microcode
 - Board-specific initialization including PCI enumeration and post-PCI enumeration initialization
 - o Serial AT Attachment (SATA) initialization
 - o Peripheral Component Interconnect Express* (PCIe*) initialization
 - Universal Serial Bus (USB) initialization
 - Power management initialization (S-states, P-states, wake events, and thermal)
 - Advanced Configuration and Power Interface (ACPI) support
 - Payload to load/boot the OS
 - Port 80 display
 - Fast boot support
 - Booting from USB2/USB3 storage devices
 - Booting from eMMC* storage device
 - IA64 mode support



1.3 Acronyms and Terms

Table 2 lists the acronyms and terms used in this document (in alphabetic order).

Table 2. Terminology

1.4 Related Documentation, Tools, and Packages

<u>Table 3</u> lists the Intel Atom® C3XXX Product Family Platform documentation.

Table 3. Intel® Firmware Support Package Documentation

Document Name	Reference Number
Intel® FSP External Architecture Specification v2.0 (FSP EAS v2.0)	http://www.intel.com/conte nt/dam/www/public/us/en/ documents/technical- specifications/fsp- architecture-spec-v2.pdf
Binary Configuration Tool (BCT) for Intel® FSP	https://github.com/IntelFsp /BCT
Linux* FSP for Intel Atom® C3XXX Product Family	https://github.com/IntelFsp /FSP



Document Name	Reference Number
Intel Atom® C3XXX Product Family Intel® Firmware Support Package (Intel® FSP) Integration Guide	335702

<u>Table 5</u> lists the tools applicable to this Intel® FSP release.

Table 4. Tool Versions

Tool	Version
Binary Configuration Tool (BCT)	3.3.1
SPS FW (CRB) version	04.00.04.168.0

1.5 Intended Audience

This document is for platform and system developers who intend to use an Intel® FSP-based bootloader for the firmware solution for their overall design based on the Intel Atom® C3XXX Product Family. This group includes system BIOS developers, bootloader developers, and system integrators.

1.6 Customer Support

Intel offers support for this software at the API level only, defined in the *Intel Atom*° *C3XXX Product Family Product Family Intel*° *Firmware Support Package Integration Guide* and reference manuals. If your field representative has created an account for you, support requests can be submitted at https://premier.intel.com.

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2.0 New in This Release

2.1 New Features

This release includes the following new features and product changes:

Fixed invalid parameter stored in SMBIOS Memory HOB.



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3.0 Intel Atom® C3XXX Product Family Software Issues and Limitations

Known and resolved issues relating to the Intel® Firmware Support Package are described in this section.

3.1 Known Issues for Intel Atom® C3XXX Product Family Product Family

None known.

3.2 Resolved Issues for Intel Atom® C3XXX Product Family

Table 5. Resolved Issues

Description	Status
Module Part Number stored in SMBIOS Memory HOB is invalid.	Fixed

3.3 Limitations for Intel Atom® C3XXX Product Family

Table 6. Limitations

Description	Status
Denverton FSP can only support IO based serial port base address, MMIO based serial port base address is not supported.	No Planned Fix

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4.0 Where to Find the Release

This package can be found on GitHub.com.

4.1 How to Install this Release

This release can be installed on a Linux* system.

4.1.1 For Linux*

- 1. Download the zipped file from https://github.com/IntelFsp/FSP.
- 2. Extract the contents of the .zip file.
- 3. Refer to the Readme_Extract.txt file for further instructions to complete the installation.

Note: For the guide to adding the Intel® FSP APIs into the bootloader code, refer to the Intel Atom® C3XXX Product Family Intel® Firmware Support Package (Intel® FSP) Integration Guide (Refer to Table 3 for more information).

4.2 Microcode Update

The IA-32 processors have the capability to correct specific errata through the loading of an Intel-supplied data block. This data block is referred to as a microcode update or system configuration data.

Each unique processor stepping/package combination has an associated microcode update that, when applied, constitutes a supported processor (i.e., Specified Processor = Processor Stepping + Microcode Update). The proper microcode update must be loaded on each processor in a system. The proper microcode update is defined as the latest microcode update available from Intel for a given family, model, and stepping of the processor. Any processor that does not have the correct microcode update loaded is considered to be operating out of specification.

Intel recommends that future microcode updates are done as soon as thelatest ones are released.

The steps for converting a microcode patch to a microcode header are as follows:

- 1. Download the latest microcode patch. This file is in text format (i.e. *.txt or *.inc).
- 2. This is a sample command to reformat the microcode patch:

```
cat {name}.TXT | awk `{print $2}' | sed `s/^/0x/' | sed `s/h/,/' > {name}.h
```



4.3 Debug

Debug messages are the primary way of debugging the Intel® FSP. There is an option to modify the Intel® FSP debug level using the BCT. The **FSP Debug Print Level** has a default value of MEDIUM DEBUG, which is the level below the highest debug level.

- 1. Start the BCT and open the DenvertonNSFsp.bsf file that was included with the Intel® FSP kit.
- 2. In the Settings Configuration->MRC & Early SoC section, set Intel® FSP Debug Print Level to the desired debug level (Range: No Debug Verbose Debug).
- 3. Save the settings in an .absf file.
- 4. Apply the settings to the Intel® FSP binary file using **Binary Tools->Patch**.

4.4 Rank Margining Tool

The RMT can flag areas of concern for platform developers. The BCT tool can be used to modify the Intel® FSP binary to enable the RMT for memory testing.

- 1. Start the BCT and open the <code>DenvertonNSFsp.bsf</code> file that was included with the <code>Intel®FSP</code> kit.
- 2. In the **Setting Configuration->MRC & Early SoC** section:
 - a. Set Enable Rank Margin Tool to Enabled.
 - b. Set RMT CPGC exp_loop_cnt to the desired value.
 - c. Set **RMT CPGC num_bursts** to the desired value.
- 3. Save the settings in an .absf file.
- 4. Apply the settings to the Intel® FSP binary file using **Binary Tools->Patch**.

4.5 Component Extraction

The Intel® FSP binary is released as a single binary. Use the python* script, SplitFspBin.py, to split the FD in to the different FSP components.

SplitFspBin.py is available at:

https://github.com/tianocore/edk2/tree/master/IntelFsp2Pkg/Tools

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The sample command shown below creates three binaries named after the input Intel® FSP binary and appended with "_M", "_S", and "_T" respectively.

python IntelFsp2Pkg\Tools\SplitFspBin.py split -f <FSP Binary>

Example: python IntelFsp2Pkg\Tools\SplitFspBin.py split -f DenvertonNSFsp.fd

Example Output:

- DenvertonNSFsp_M.fd
- DenvertonNSFsp_S.fd
- DenvertonNSFsp_T.fd

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5.0 Release Content

This release package contains the following contents.

Table 7. Package Contents

Description	Filename	Path
Intel® FSP Kit License File	DenvertonNSFspKitProductionRULACLi cense.pdf	
Intel® FSP Binary File	DenvertonNSFsp.fd	DenvertonNSFspBinPkg/FspBin
Boot Setting File (BSF)	DenvertonNSFsp.bsf	DenvertonNSFspBinPkg/FspBin
	DenvertonNSFspIntegrationGuide.pdf DenvertonNSFspReleaseNotes.pdf	DenvertonNSFspBinPkg/Docs
Text File Copy of Intel® FSP Kit License File (Linux* only)	license.txt	DenvertonNSFspBinPkg/Docs
Sample File	FsptUpd.h FspmUpd.h FspsUpd.h FspUpd.h	DenvertonNSFspBinPkg/Include

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6.0 Hardware and Software Compatibility

6.1 Supported Hardware

The Intel® FSP included in this release is specifically targeted for the Intel Atom® C3XXX Product Family Product Family System on a Chip (SoC).

6.2 Supported Operating Systems

This release installs on either a Windows* or a Linux* system. However, the Intel® FSP binary itself can be used with any software development environment to generate a complete bootloader solution.

The software in this release has been validated against the operating systems given in <u>Table 9</u> on the Customer Reference Boards (CRBs) for Intel Atom® C3XXX Product Family.

Note: While the Intel® FSP is validated on the Coreboot* and Yocto* operating systems on the respective platforms, it is designed to work without any changes on some other bootloader and operating systems.

Table 8. Operating System/Bootloader Support

Software Type	Name	Version
Bootloader	coreboot*	4.6
Payload Bootloader	UEFI Payload	PC 001
Firmware Component	SPS ME Firmware	04.00.04.168.0
Firmware Component	Intel® FSP	PV002
Operating System	Yocto*	2.0
Tool	ВСТ	3.3.1

Validation was done on Intel® Atom® C3XXX SoC B1 (QMEH) stepping only.



7.0 Configuration

A Binary Configuration Tool (BCT) for the Intel® FSP is provided as a companion tool and is intended to be used to:

- Customize the Intel® FSP binary configuration options based on the Boot Setting File (BSF).
- Rebase the Intel® FSP binary to a different base address (the default base address of the Intel® FSP for Intel Atom® C3XXX Product Family is 0xFFF30000).

Intel recommends using the latest BCT with this release.

Refer to the *BCT User Guide* for usage instructions. Refer to <u>Section 1.4</u> to obtain the BCT.

7.1 Intel® Firmware Support Package Information

To obtain the Intel® FSP binary information:

- 1. Run the Binary Configuration Tool.
- 2. Click the **Show Binary Description** command button.
- 3. Select the Intel® FSP binary. For this release, the binary included is named as: DenvertonNSFsp.fd
- 4. Click **Open**. Another window will open and show the Intel® FSP binary information.
- 5. Click **OK** to close the window.



This FSP Release has the following Binary Description.

FSP-T Header Details:

- This FSP supports the following:
 - Deverton NS SoC
 - Build: 0015.D85
- FSP Header:
 - Signature: FSPH
 - Header Length: 0x48
 - Header Revision: 0x3
 - SpecVersion: 0x20
 - Image Revision: 0x110
 - Image ID: DNV-FSP0
 - Image Size: 0x1000
 - Image Base: 0xfff30000
 - Image Attribute: 0x10030000
 - Configuration Region Offset: 0x18c

 - Configuration Region Size: 0x80
 - API Entry Num: 0x0
 - Temp RAM Init Entry: 0x4cd
 - FSP Init Entry: 0x0
 - Notify Phase Entry: 0x0
 - FSP Memory Init Entry: 0x0
 - Temp RAM Exit Entry: 0x0
 - FSP Silicon Init Entry: 0x0
- FSP Extended Header:
 - Signature: FSPE
 - Header Length: 0x18
 - Header Revision: 0x1
 - FSP Producer Id: INTELC
 - FSP Producer Revision: 0x1



FSP-M Header Details:

- This FSP supports the following:
 - Deverton NS SoC
 - Build: 0015.D85
- FSP Header:
 - Signature: FSPH
 - Header Length: 0x48
 - Header Revision: 0x3
 - SpecVersion: 0x20
 - Image Revision: 0x110
 - Image ID: DNV-FSP0
 - Image Size: 0x90000
 - Image Base: 0xfff32000
 - Image Attribute: 0x20030000
 - Configuration Region Offset: 0x18c
 - Configuration Region Size: 0x200
 - API Entry Num: 0x0
 - Temp RAM Init Entry: 0x0
 - FSP Init Entry: 0x0
 - Notify Phase Entry: 0x0
 - FSP Memory Init Entry: 0x460
 - Temp RAM Exit Entry: 0x46a
 - FSP Silicon Init Entry: 0x0
- FSP Extended Header:
 - Signature: FSPE
 - Header Length: 0x18
 - Header Revision: 0x1
 - FSP Producer Id: INTELC
 - FSP Producer Revision: 0x1



FSP-S Header Details:

- This FSP supports the following:
 - Deverton NS SoC
 - Build: 0015.D85
- FSP Header:
 - Signature: FSPH
 - Header Length: 0x48
 - Header Revision: 0x3
 - SpecVersion: 0x20
 - Image Revision: 0x110
 - Image ID: DNV-FSP0
 - Image Size: 0x19000
 - Image Base: 0xfffc3000
 - Image Attribute: 0x30030000
 - Configuration Region Offset: 0x18c
 - Configuration Region Size: 0x100
 - API Entry Num: 0x0
 - Temp RAM Init Entry: 0x0
 - FSP Init Entry: 0x0
 - Notify Phase Entry: 0x350
 - FSP Memory Init Entry: 0x0
 - Temp RAM Exit Entry: 0x0
 - FSP Silicon Init Entry: 0x35a
- FSP Extended Header:
 - Signature: FSPE
 - Header Length: 0x18
 - Header Revision: 0x1
 - FSP Producer Id: INTELC
 - FSP Producer Revision: 0x1

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